

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
60V	1.6Ω@10V	340mA
	1.8Ω@4.5V	
-60V	4.2Ω@-10V	-130mA
	4.5Ω@-4.5V	

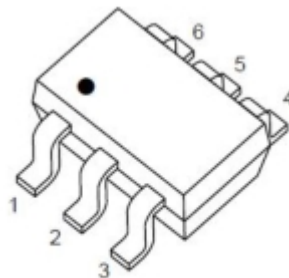
## Feature

- Complimentary Pairs
- Low On-Resistance
- Low Gate Threshold Voltage
- Fast Switching
- ESD protected Gate HBM 2KV

## Application

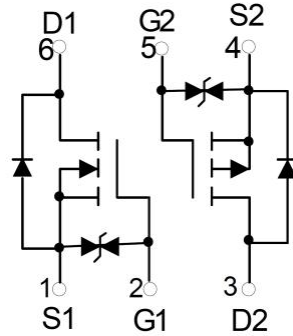
- Switching Power Supplies
- Hand-Held Computer, PDAS

## Package

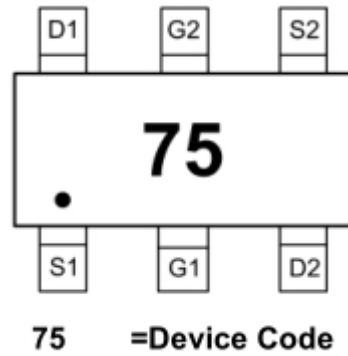


**SOT-363**

## Circuit diagram



## Marking



## Maximum Ratings-Total Device

( $T_a=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Power Dissipation	$P_D$	0.15	mW
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}\text{C}$

## Maximum Ratings - N-Channel Q1

( $T_a=25^{\circ}\text{C}$  unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	340	mA

## Maximum Ratings - P-Channel Q1

(T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	130	mA

## Thermal Characteristics

(T<sub>a</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	833	°C/W

## Electrical characteristics - N-Channel Q1

(T<sub>A</sub>=25°C, unless otherwise noted)

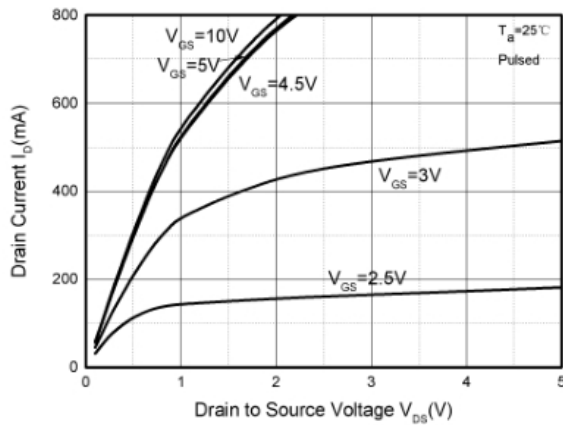
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV (BR)DSS	V <sub>GS</sub> = 0V, I <sub>D</sub> =250μA	60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =48V, V <sub>GS</sub> = 0V			1	uA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V			±10	uA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1	1.6	2.5	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =250mA		1.6	3	Ω
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =250mA		1.8	4	
Dynamic Characteristics						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz		28		pF
Output capacitance	C <sub>OSS</sub>			9		
Reverse transfer capacitance	C <sub>rss</sub>			2		
Switching Characteristics						
Turn-on Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> =30V, R <sub>L</sub> =150Ω, I <sub>D</sub> =200mA, V <sub>GEN</sub> =10V, R <sub>G</sub> =10Ω		8.5		nS
Turn-on Rise Time	T <sub>r</sub>			6		
Turn-Off Delay Time	T <sub>d(off)</sub>			31.8		
Turn-Off Fall Time	t <sub>f</sub>			15.5		
Source-Drain Diode Characteristics						
Diode Forward Voltage		I <sub>S</sub> =200mA, V <sub>GS</sub> =0V		0.82	1.3	V

## Electrical characteristics - P-Channel Q2

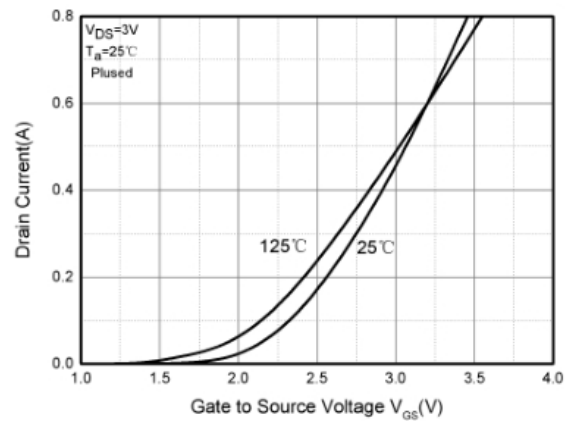
(T<sub>A</sub>=25°C, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV (BR)DSS	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -48V, V <sub>GS</sub> = 0V			-1	uA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±10	uA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-1.0	-1.8	-2.5	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = -0.1A		4.2	6	Ω
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.1A		4.5	7	
Dynamic Characteristics						
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -5V, V <sub>GS</sub> =0V, f=1MHz		30		pF
Output capacitance	C <sub>oss</sub>			10		
Reverse transfer capacitance	C <sub>rss</sub>			5		
Switching Characteristics						
Turn-on Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> = -15V, R <sub>L</sub> =50Ω, , I <sub>D</sub> = -2.5A		2.5		nS
Turn-on Rise Time	T <sub>r</sub>			1		
Turn-Off Delay Time	T <sub>d(off)</sub>			16		
Turn-Off Fall Time	t <sub>f</sub>			8		
Source-Drain Diode Characteristics						
Diode Forward Voltage <sup>1)</sup>	V <sub>SD</sub>	I <sub>S</sub> = -0.5A, V <sub>GS</sub> =0V			-1.3	V

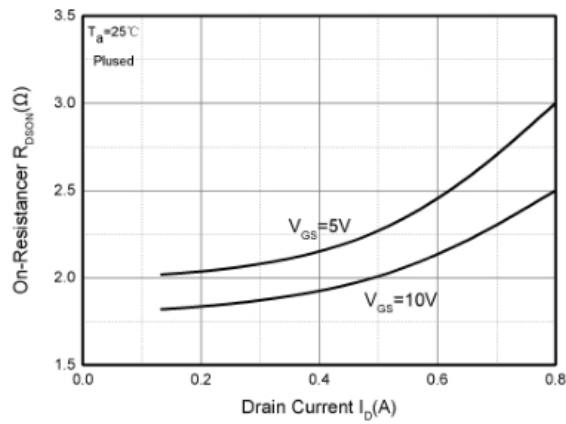
## Typical Characteristics - N-Channel Q1



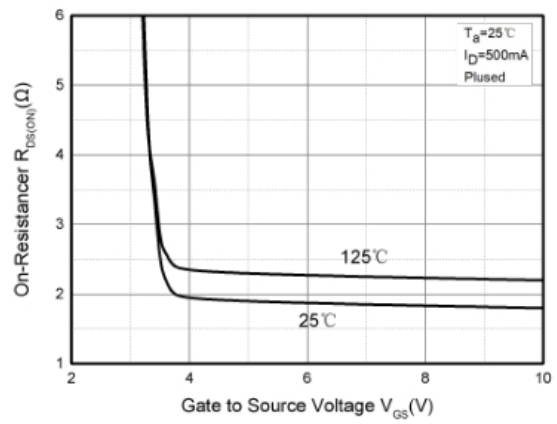
Output Characteristics



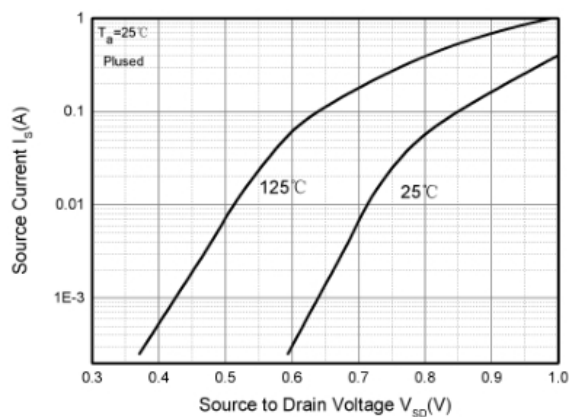
Transfer Characteristics



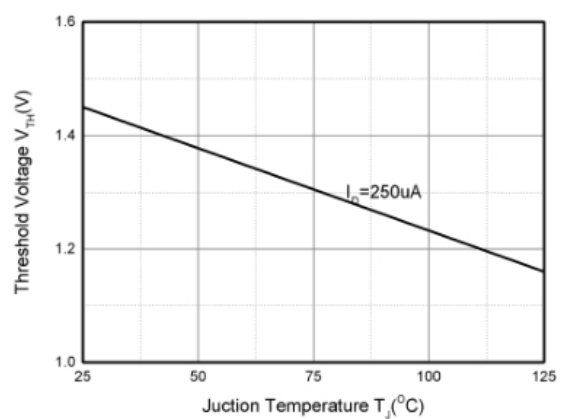
On-Resistance vs. Drain current



On-Resistance vs. Gate to Source Voltage

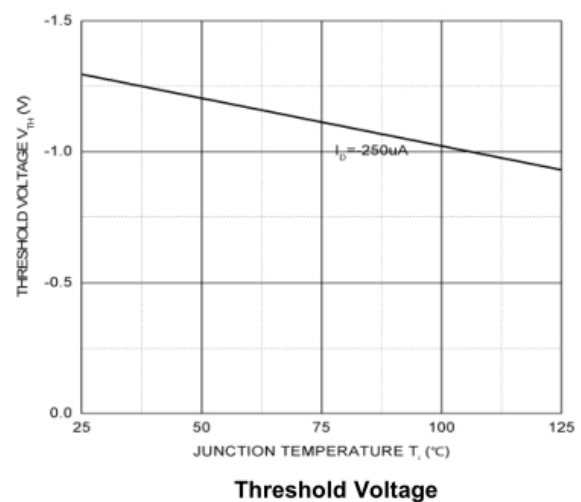
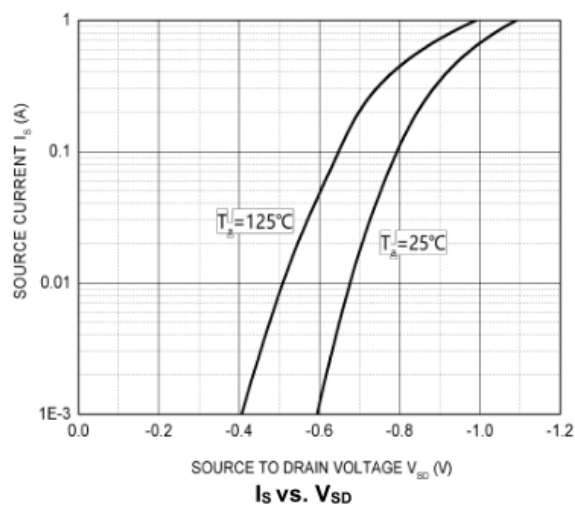
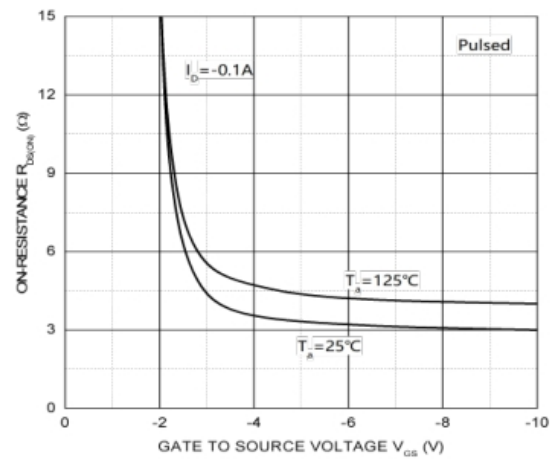
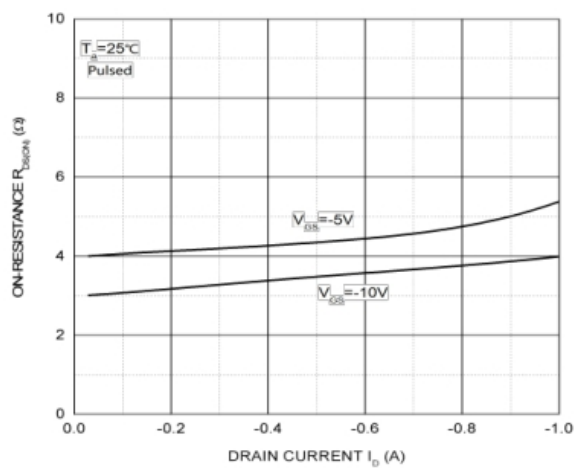
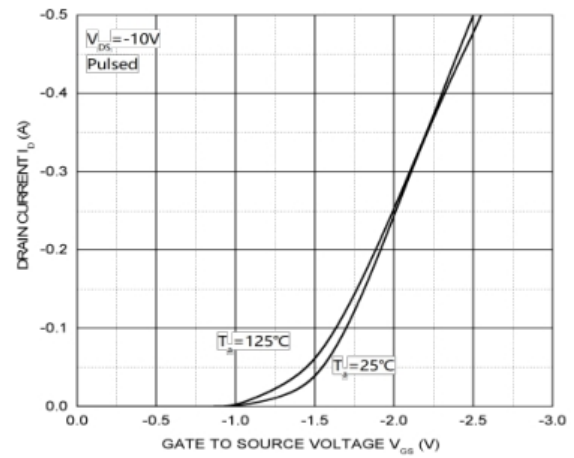
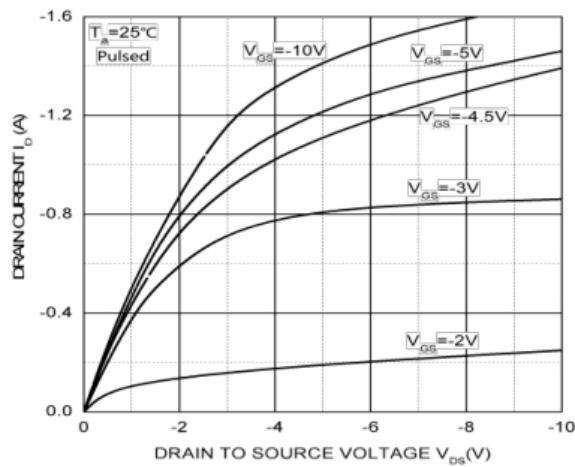


Source Current vs. Source to Drain Voltage

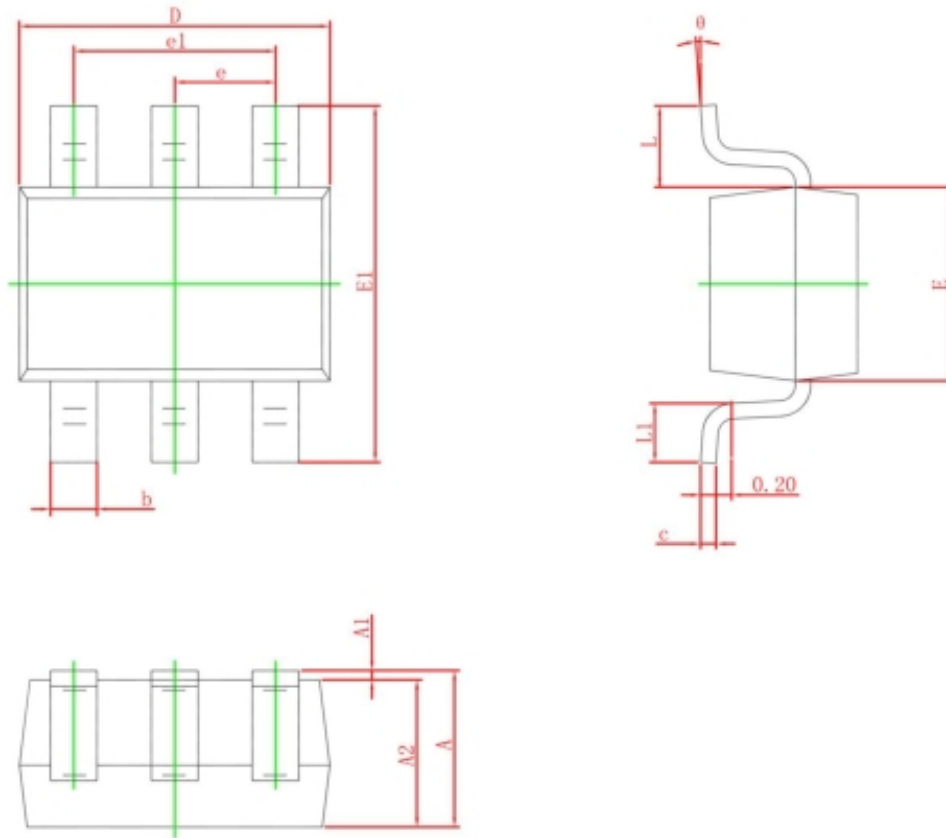


Threshold voltage vs. Junction temperature

## Typical Characteristics - P-Channel Q2



## SOT-363 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.150	0.350	0.006	0.014
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.525 REF.		0.021 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°